









PRODUCT DATASHEET



- ► Ceramic High Power
- ➤ 3535 Series 2.5t
- ► Infrared (850nm)

N0F39S85



3535 2.5t Series





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APPLICATIONS:

- Security Camera
- Motion Detection
- Night Viewer
- **Switch Sensor**
- **Smoke Detector**

FEATURES:

- Package: Ceramic SMT Package with Silicon Lens
- Forward Current: 350mA Forward Voltage (typ.): 2.0V
- Radiant Intensity(typ.): 100mW/sr@350mA
- Colour: Infrared (IR) Wavelength: 850nm Viewing angle: 90°
- **Materials:**
 - Die: AlGaInP
 - Resin: Silicon (Water Clear)
 - L/F: Ceramic
- Operating Temperature: -40~+100°C Storage Temperature: -40~+100°C
- **Grouping parameters:**
 - Forward Voltage
 - **Radiant Intensity**
 - Peak Wavelength
- Soldering methods: Reflow
- Preconditioning: MSL3 according to J-STD020
- Packing: 12mm tape with 100pcs Min./reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	500	mA
Pulse Forward Current Duty 1/10@10KHz	Ipf	1000	mA
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	1.45	W
Junction Temperature	Tj	115	°C
Electrostatic Discharge (HBM) 100pf/1.5KΩ	r.c.	2000	V
Electrostatic Discharge (MM) 200pf/0κΩ	ESD	150	V
Operating Temperature	Topr	-40~+100	°C
Storage Temperature T _{STG}		-40~+100	°C
Thermal Resistance		8	°C/W
Soldering Temperature	T _P	260	°C

Electrical & Optical Characteristics (Ta=25°C)

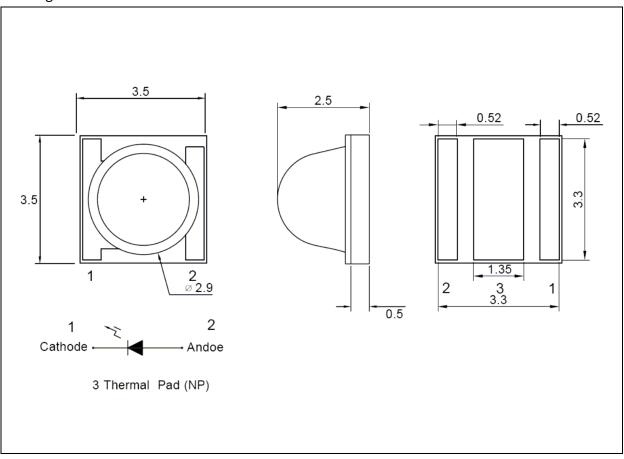
Parameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	VF	1.7		2.9	V	I _F =350mA
Radiant Intensity	le	70	100		mW/sr	I _F =350mA
Peak Wavelength	λ_{P}		850		nm	I _F =350mA
Spectral Half Width	Δλ		40		nm	I _F =350mA
Viewing Angle	2θ _{1/2}		90		deg	I _F =350mA

^{1.} Radiant Intensity $\pm 15\%$, Forward Voltage $\pm 0.1 V$



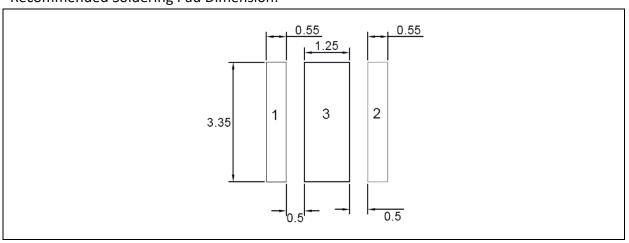
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 350mA):

Code	Min.	Max.	Unit
1	1.7	2.0	
2	2.0	2.3	W
3	2.3	2.6	V
4	2.6	2.9	

Radiant Intensity Classifications (IF = 350mA):

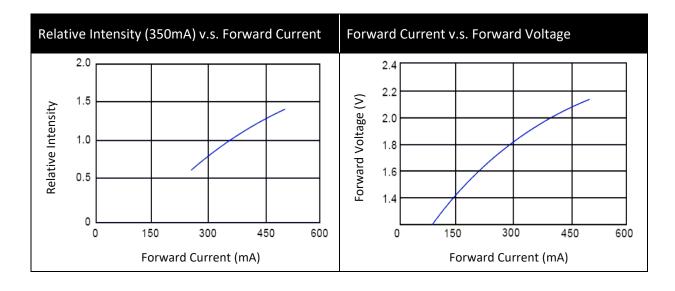
Code	Min.	Max.	Unit
D6	70	80	
D7	80	90	ma\A//am
D8	90	100	mW/sr
D9	120	140	

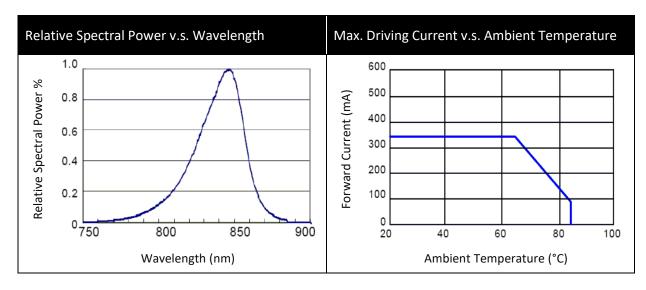
Peak Wavelength Classifications (I_F = 350mA):

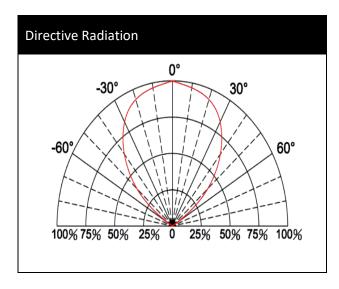
Code	Min.	Max.	Unit
IR1	830	870	nm



ELECTRO-OPTICAL CHARACTERISTICS:





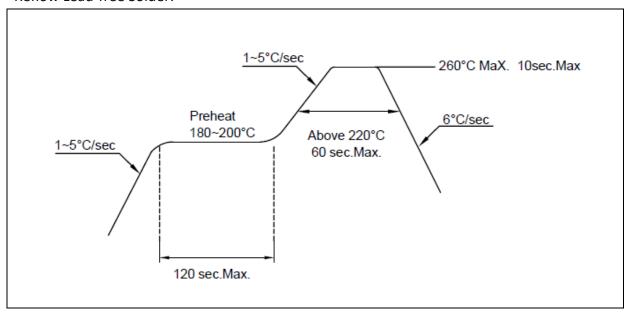


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RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



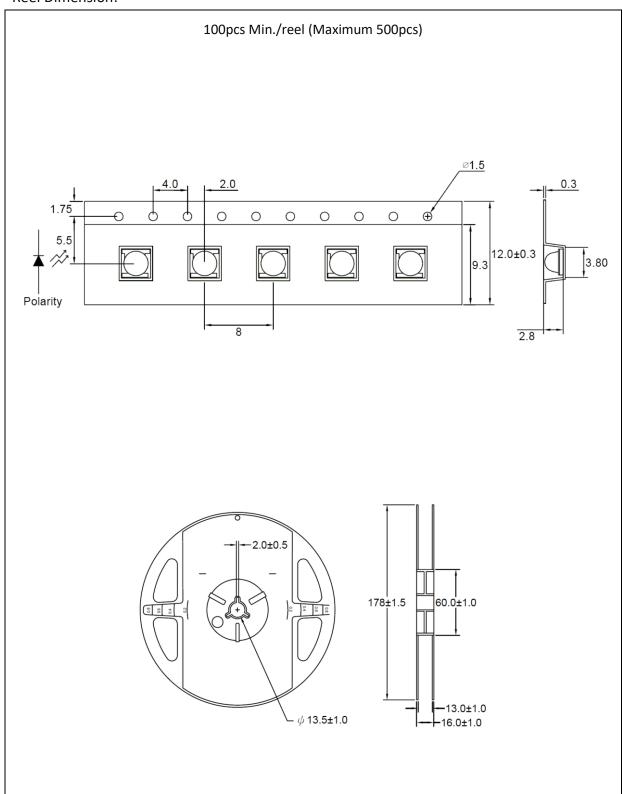
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

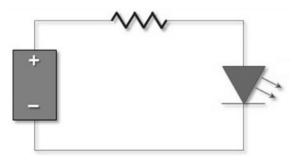
It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 24hrs before use.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	20/07/2017	Datasheet set-up.